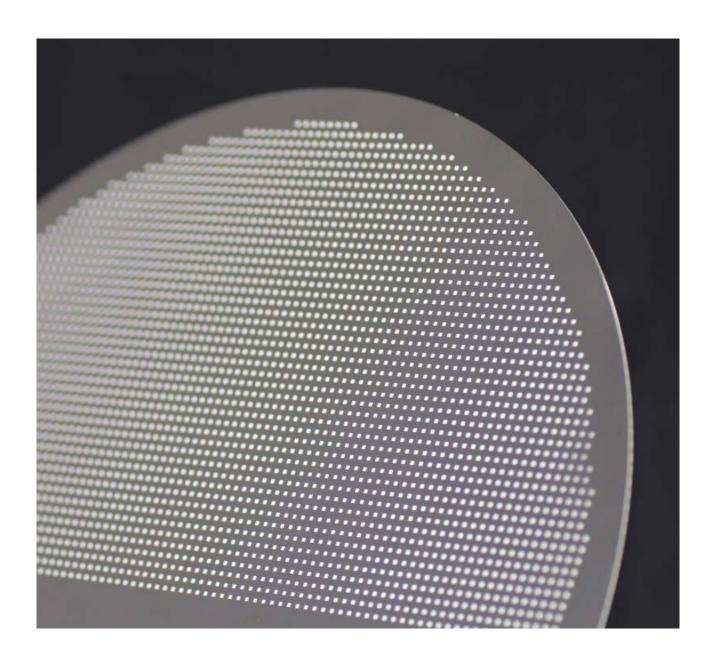
Glass Capping Wafer Higher Densities in Wafer Level Packaging by Glass Cavities with Steep Side Walls







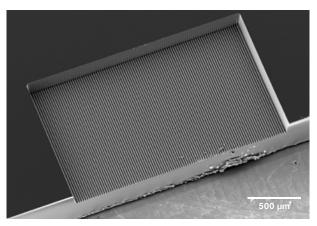
Capping Wafer

- Glass thickness: < 1 mm
- Cavity depth: > 0.3 mm
- Positional accuracy: ±5 µm
- Side wall angle: 1° to 7° (depending on glass type)

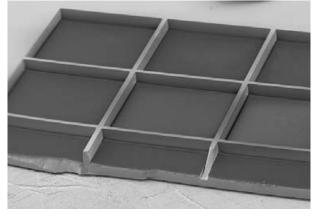
- Roughness of bottom surface: Ra 0,5 µm
- Possible aspect ratio > 1:1
- Substrate size: All standard wafer sizes up to 450 mm and panels up to 510 mm x 510 mm



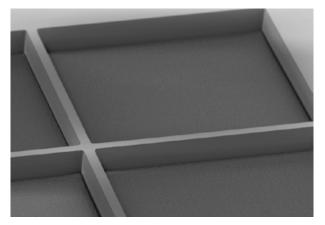
Glass capping wafer



Closed cavity



Array of cavities



Detailed view on glass cavity



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